



Docket No.: MAS-FIN-128

Receipt

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.

By: *Loren D. Pearson*

Date: 3/19/02

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APR - 8 2002
TECHNOLOGY CENTER 2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Harry Hedler et al.
Appl. No. : 10/056,356
Filed : January 24, 2002
Title : Electronic Component with a Semiconductor Chip and Method of
Producing the Electronic Component
Art Unit : 2831

Request for Filing Receipt Correction

Hon. Commissioner of Patents and Trademarks,
Washington, D.C. 20231

Sir:

Undersigned counsel has received the Filing Receipt for the above-identified application.

However, the applicant information was listed incorrectly and should be as follows:

Harry Hedler, Jahnstr. 8, D-82110 Germering, Germany
Bernd Römer, Pfalzgrafenstr. 8B, D-93170 Bernhardswald, Germany

It is respectfully requested that the Patent Office Records be changed and that a new Filing Receipt be issued, so that the printed patent will show the correct applicant information.

Respectfully submitted,

Loren D. Pearson
LOREN DONALD PEARSON
REG NO. 42,987

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/kf

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF FIRST JOINT INVENTOR:

HARRY HEDLER

INVENTOR'S SIGNATURE: _____

Harry Hedler

DATE: 31.01.02

Residence: REGENSBURG, GERMANY

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FULL NAME OF SECOND JOINT INVENTOR:

BERND RÖMER

INVENTOR'S SIGNATURE: _____

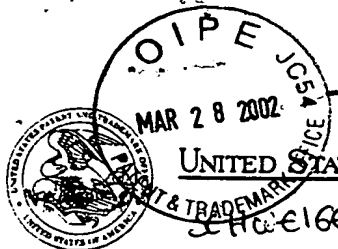
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UNITED STATES PATENT AND TRADEMARK OFFICE

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WASHINGTON, D.C. 20231
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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/056,356	01/24/2002	2831	866	MAS-FIN-128	2	27	2

CONFIRMATION NO. 8042

FILING RECEIPT



OC000000007516407

LERNER AND GREENBERG, P.A.
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Date Mailed: 02/22/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Harry Hedler, Regensburg, GERMANY;
Bernd Romer, Bernhardswald, GERMANY;

Domestic Priority data as claimed by applicant

Foreign Applications

GERMANY 101 03 186.6-33 01/24/2001

If Required, Foreign Filing License Granted 02/21/2002

Projected Publication Date: To Be Determined - pending completion of Missing Parts

Non-Publication Request: No

Early Publication Request: No

Title

Electronic component with a semiconductor chip and method of producing the electronic component

Preliminary Class

174

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